

LOCTITE[®] M-21HP™

June 2009

PRODUCT DESCRIPTION

LOCTITE[®] M-21HP™ provides the following product

characteristics:	
Technology	Ероху
Chemical Type	Ероху
Appearance (Resin)	Off-white to beige liquid ^{LMS}
Appearance (Hardener)	Light straw colored liquid LMS
Appearance (Mixed)	Off-white
Components	Two part - Resin & Hardener
Viscosity	Medium
Mix Ratio, by weight - Resin : Hardener	100 : 55
Mix Ratio, by volume - Resin : Hardener	2:1
Cure	Room temperature cure after mixing
Application	Bonding

LOCTITE[®] M-21HP[™] cures at room temperature once mixed, to form a tough, off-white bondline which provides high peel resistance and high shear strengths. The fully cured epoxy is resistant to a wide range of chemicals and solvents, and acts as an excellent electrical insulator. LOCTITE[®] M-21HP[™] high performance epoxy provides excellent bond strengths to a wide variety of substrates including glass, plastics and metals. Suitable for use in the assembly of **disposable medical devices**.

ISO-10993

Resin[.]

Specific Gravity @ 25 °C

An ISO 10993 Test Protocol is an integral part of the Quality Program for LOCTITE[®] M-21HP[™]. LOCTITE[®] M-21HP[™] has been qualified to Henkel's ISO 10993 Protocol as a means to assist in the selection of products for use in the medical device industry. Certificates of Compliance are available on Henkel's website or through the Henkel Quality Department.

1.0

TYPICAL PROPERTIES OF UNCURED MATERIAL

Flash Point - See MSDS	
Viscosity, Brookfield - RVT, 25 °C, mPa·s ((cP):
Spindle 7, speed 20 rpm	40,000 to 90,000 ^{LMS}
Hardener:	
Specific Gravity @ 25 °C	1.1
Flash Point - See MSDS	
Viscosity, Brookfield - RVT, 25 °C, mPa·s ((cP):
Spindle 6, speed 50 rpm	5,500 to 8,000 ^{LMS}
Mixed:	
Specific Gravity @ 25 °C	1.03

TYPICAL CURING PERFORMANCE

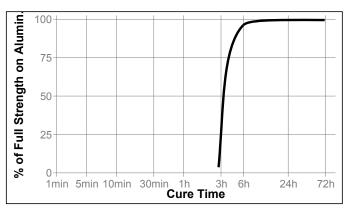
Gel Time Gel time, 22 °C, minutes	10 to 25 ^{LMS}
Working Life Working life, minutes	20
Tack Free Time	

Tack Free Time is the time required to achieve a tack free surface

Tack Free Time, minutes40

Cure Speed vs. Time

The graph below shows shear strength developed with time on Aluminum (etched & abraded) lapshears @ 25 $^{\circ}$ C with an average bondline gap of 0.1 to 0.2 mm and tested according to ISO 4587.



TYPICAL PROPERTIES OF CURED MATERIAL

Cured @ 25 °C except where noted Physical Properties:		
Glass Transition Temperature, ASTM E 228, °	С	60
Elongation, ISO 527-2, %		8
Tensile Strength, ISO 527-2	N/mm² (psi)	39 (5,700)
Shore Hardness, ISO 868, Durometer D:		
Cured @ 22 °C for 16 to 18 hours followed by 2 hours @ 65 °C	74	to 84 ^{∟MS}
Electrical Properties:		
Dielectric Breakdown Strength, IEC 60243-1, kV/mm		20

TYPICAL PERFORMANCE OF CURED MATERIAL Adhesive Properties

Cured @ 65 °C for 2 hours Lap Shear Strength, ISO 4587: Aluminum (etched & abraded), 0.127 mm gap	N/mm² (psi)	≥6.9 ^{∟мs} (≥1,000)
Cured @ 22 °C for 5 days Lap Shear Strength, ISO 4587: Steel (grit blasted)	N/mm² (psi)	22.6 (3,270)

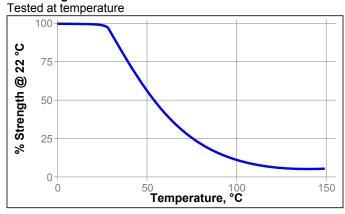


Aluminum (etched & abraded), 0.1 to 0.2 mm gap Aluminum (anodised)	N/mm² (psi) N/mm² (psi)	(4,090) 17.4
Stainless steel	(psi) N/mm² (psi)	22.0
Polycarbonate	N/mm² (psi)	3.9
Nylon	N/mm² (psi)	` '
Wood (Fir)	N/mm² (psi)	11.4 (1,660)
Block Shear Strength, ISO 13445:		
PVC	N/mm² (psi)	7.9 (1,140)
ABS	N/mm² (psi)	10.4 (1,510)
Epoxyglass	N/mm² (psi)	28.6 (4,140)
Acrylic	N/mm² (psi)	
Glass	N/mm² (psi)	32.3 (4,690)

TYPICAL ENVIRONMENTAL RESISTANCE

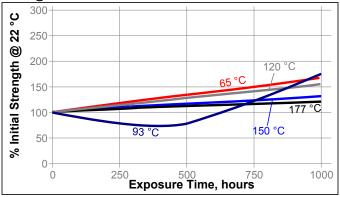
Cured for 12 hours @ 65 °C followed by 4 hours @ 22 °C Lap Shear Strength, ISO 4587: Aluminum (etched & abraded), 0.1 to 0.2 mm gap

Hot Strength



Heat Aging

Cured for 5 days @ 22 °C, on steel, aged at temperatures indicated, tested @ 22 °C



Chemical/Solvent Resistance

Cured for 5 days @ 22 °C, on steel, aged under conditions indicated and tested @ 22°C

		% of initial strength		
Environment	°C	500 h	1000 h	
Air	87		135	
Motor oil (10W30)	87	160	170	
Unleaded gasoline	87	105	80	
Water/glycol 50/50	87	120	125	
Salt fog	22		70	
95% RH	38		100	
Condensing Humidity	49		90	
Water	22		80	
Acetone	22	75	95	
Isopropanol	22	85	125	

Effects of Sterilization

In general, products similiar in composition to LOCTITE® M-21HP[™] subjected to standard sterilization methods. such as EtO and Gamma Radiation (25 to 50 kiloGrays cumulative) show excellent bond strength retention. LOCTITE[®] M-21HP™ maintains bond strength after 1 cycle of steam autoclave. It is recommended that customers test specific parts after subjecting them to the perferred sterilization method. Consult with Loctite[®] for a product recommendation if your device will see more than 3 sterilization cycles.

GENERAL INFORMATION

This product is not recommended for use in pure oxygen and/or oxygen rich systems and should not be selected as a sealant for chlorine or other strong oxidizing materials

For safe handling information on this product, consult the Material Safety Data Sheet (MSDS).

Directions for use:

- 1. For high strength structural bonds, remove surface contaminants such as paint, oxide films, oils, dust, mold release agents and all other surface contaminants.
- 2. Use gloves to minimize skin contact. DO NOT use solvents for cleaning hands.
- 3. Dual Cartridges: To use simply insert the cartridge into the application gun and start the plunger into the cylinders using light pressure on the trigger. Next, remove the cartridge cap and expel a small amount of adhesive to be sure both sides are flowing evenly and freely. If automatic mixing of resin and hardener is desired, attach the mixing nozzle to the end of the cartridge and begin dispensing the adhesive. For hand mixing, expel the desired amount of the adhesive and mix thoroughly. Mix for approximately 15 seconds after uniform color is obtained.
- 4. For maximum bond strength apply adhesive evenly to both surfaces to be joined.
- 5. Application to the substrates should be made within 20 minutes. Larger quantities and/or higher temperatures will reduce this working time.
- 6. Join the adhesive coated surfaces and allow to cure at 25 °C for 24 hours for high strength. Heat up to 93 °C, will speed curing.

- 7. Keep parts from moving during cure. Contact pressure is neccesary. Maximum shear strength is obtained with a 0.1 to 0.2 mm bond line.
- 8. Excessive uncured adhesive can be cleaned up with ketone type solvents.

Loctite Material Specification^{LMS}

LMS dated June 5, 2000. Test reports for each batch are available for the indicated properties. LMS test reports include selected QC test parameters considered appropriate to specifications for customer use. Additionally, comprehensive controls are in place to assure product quality and consistency. Special customer specification requirements may be coordinated through Henkel Quality.

Storage

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

Optimal Storage: 8 °C to 21 °C. **Storage below** 8 °C or **greater than 28** °C **can adversely affect product properties**. Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

Conversions

 $(^{\circ}C \ge 1.8) + 32 = ^{\circ}F$ kV/mm $\ge 25.4 =$ V/mil mm / 25.4 = inches μ m / 25.4 = mil N $\ge 0.225 =$ lb N/mm $\ge 5.71 =$ lb/in N/mm² $\ge 145 =$ psi MPa $\ge 145 =$ psi MPa $\ge 145 =$ psi N·m $\ge 8.851 =$ lb·in N·m $\ge 0.738 =$ lb·ft N·mm $\ge 0.142 =$ oz·in mPa·s = cP

Note

The data contained herein are furnished for information only and are believed to be reliable. We cannot assume responsibility for the results obtained by others over whose methods we have no control. It is the user's responsibility to determine suitability for the user's purpose of any production methods mentioned herein and to adopt such precautions as may be advisable for the protection of property and of persons against any hazards that may be involved in the handling and use thereof. In light of the foregoing, Henkel Corporation specifically disclaims all warranties expressed or implied, including warranties of merchantability or fitness for a particular purpose, arising from sale or use of Henkel Corporation's products. Henkel Corporation specifically disclaims any liability for consequential or incidental damages of any kind, including lost profits. The discussion herein of various processes or compositions is not to be interpreted as representation that they are free from domination of patents owned by others or as a license under any Henkel Corporation patents that may cover such processes or compositions. We recommend that each prospective user test his proposed application before repetitive use, using this data as a guide. This product may be covered by one or more United States or foreign patents or patent applications.

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Reference 1.1